## 2SK2129

### Silicon N-Channel Power F-MOS FET

#### ■ Features

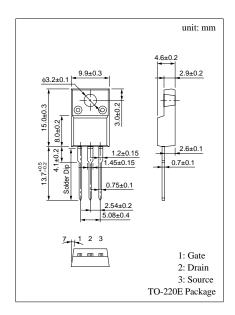
- Avalanche energy capacity guaranteed: EAS > 20mJ
- $\bullet$  V<sub>GSS</sub> =  $\pm 30$ V guaranteed
- $\bullet$  High-speed switching:  $t_f = 50$ ns
- No secondary breakdown

#### ■ Applications

- Contactless relay
- Diving circuit for a solenoid
- Driving circuit for a motor
- Control equipment
- Switching power supply

#### ■ Absolute Maximum Ratings $(T_C = 25^{\circ}C)$

Parameter		Symbol	Ratings	Unit	
Drain to Source breakdown voltage		V <sub>DSS</sub>	800	V	
Gate to Source voltage		V <sub>GSS</sub>	±30	V	
Drain current	DC	$I_{\mathrm{D}}$	±3	A	
	Pulse	$I_{DP}$	±6	A	
Avalanche energy capacity		EAS*	20	mJ	
Allowable power	$T_C = 25^{\circ}C$	D	50	W	
dissipation	Ta = 25°C	$P_{\rm D}$	2		
Channel temperature		T <sub>ch</sub>	150	°C	
Storage temperature		$T_{stg}$	-55 to +150	°C	

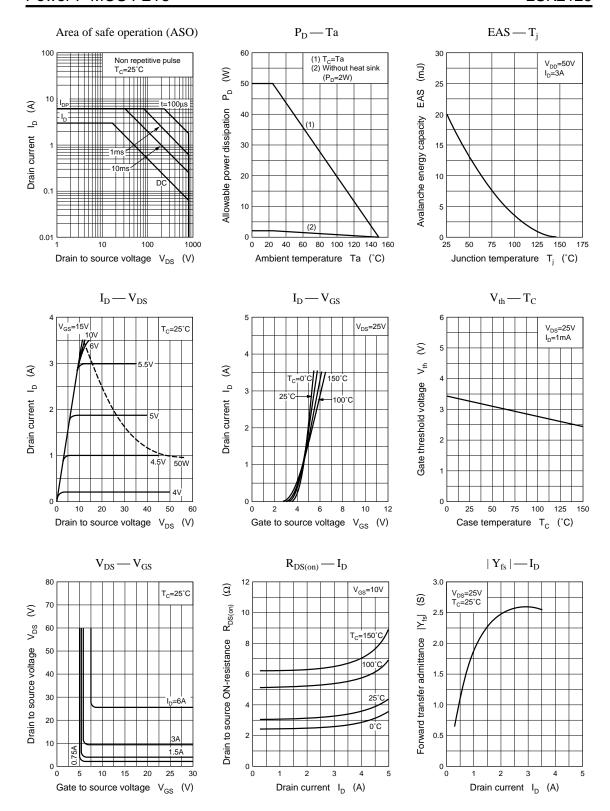


#### ■ Electrical Characteristics (T<sub>C</sub> = 25°C)

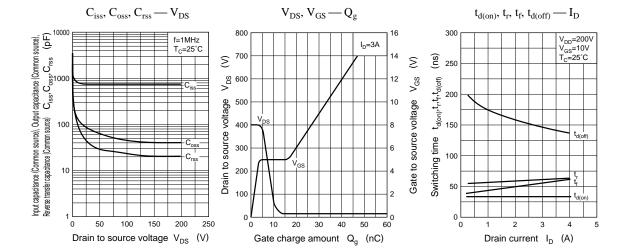
Parameter	Symbol	Conditions	min	typ	max	Unit
Drain to Source cut-off current	$I_{DSS}$	$V_{DS} = 640V, V_{GS} = 0$			0.1	mA
Gate to Source leakage current	$I_{GSS}$	$V_{GS} = \pm 30V, \ V_{DS} = 0$			±1	μА
Drain to Source breakdown voltage	V <sub>DSS</sub>	$I_D = 1$ mA, $V_{GS} = 0$	800			V
Gate threshold voltage	V <sub>th</sub>	$V_{DS} = 25V, I_D = 1mA$	2		5	V
Drain to Source ON-resistance	R <sub>DS(on)</sub>	$V_{GS} = 10V, I_D = 2A$		3.2	4	Ω
Forward transfer admittance	Y <sub>fs</sub>	$V_{DS} = 25V, I_{D} = 2A$	1.5	2.4		S
Diode forward voltage	V <sub>DSF</sub>	$I_{DR} = 3A, V_{GS} = 0$			-1.6	V
Input capacitance (Common Source)	C <sub>iss</sub>			730		pF
Output capacitance (Common Source)	C <sub>oss</sub>	$V_{DS} = 20V, V_{GS} = 0, f = 1MHz$		90		pF
Reverse transfer capacitance (Common Source)	C <sub>rss</sub>			40		pF
Turn-on time (delay time)	t <sub>d(on)</sub>			35		ns
Rise time	t <sub>r</sub>	$V_{GS} = 10V, I_D = 2A$		60		ns
Fall time	$t_{\rm f}$	$V_{DD} = 200V, R_L = 100\Omega$		50		ns
Turn-off time (delay time)	t <sub>d(off)</sub>			160		ns
Thermal resistance between channel and case	R <sub>th(ch-c)</sub>				2.5	°C/W

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<sup>\*</sup> L = 4.5mH,  $I_L = 3$ A,  $V_{DD} = 50$ V, 1 pulse



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